

MOS FIELD EFFECT TRANSISTOR 2SK4213

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

The 2SK4213 is N-channel MOS FET device that features a low on-state resistance and excellent switching characteristics, and designed for low voltage high current applications such as DC/DC converter with synchronous rectifier.

FEATURES

- Low on-state resistance
 $R_{DS(on)1} = 6.0 \text{ m}\Omega \text{ MAX. (} V_{GS} = 10 \text{ V, } I_D = 30 \text{ A)}$
 $R_{DS(on)2} = 9.5 \text{ m}\Omega \text{ MAX. (} V_{GS} = 4.5 \text{ V, } I_D = 20 \text{ A)}$
- Low total gate charge
 $Q_G = 34 \text{ nC TYP. (} V_{DD} = 15 \text{ V, } V_{GS} = 10 \text{ V, } I_D = 30 \text{ A)}$
- 4.5 V drive available
- Avalanche capability ratings

ORDERING INFORMATION

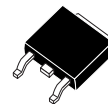
| PART NUMBER | LEAD PLATING | PACKING | PACKAGE |
|----------------------------------|---------------|------------------|-----------------------------|
| 2SK4213-ZK-E1-AY ^{Note} | Pure Sn (Tin) | Tape 2500 p/reel | TO-252 (MP-3ZK) typ. 0.27 g |
| 2SK4213-ZK-E2-AY ^{Note} | | | |

Note Pb-free (This product does not contain Pb in external electrode).

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C)

| | | | |
|-------------------------------------------------|-----------------------|-------------|----|
| Drain to Source Voltage (V _{GS} = 0 V) | V _{DSS} | 25 | V |
| Gate to Source Voltage (V _{DS} = 0 V) | V _{GSS} | ±20 | V |
| Drain Current (DC) (T _C = 25°C) | I _{D(DC)} | ±64 | A |
| Drain Current (pulse) ^{Note1} | I _{D(pulse)} | ±192 | A |
| Total Power Dissipation (T _C = 25°C) | P _{T1} | 45 | W |
| Total Power Dissipation (T _A = 25°C) | P _{T2} | 1.0 | W |
| Channel Temperature | T _{ch} | 150 | °C |
| Storage Temperature | T _{stg} | -55 to +150 | °C |
| Single Avalanche Current ^{Note2} | I _{AS} | 21 | A |
| Single Avalanche Energy ^{Note2} | E _{AS} | 44 | mJ |

(TO-252)



Notes 1. PW ≤ 10 μs, Duty Cycle ≤ 1%

2. Starting T_{ch} = 25°C, V_{DD} = 12.5 V, R_G = 25 Ω, V_{GS} = 20 → 0 V, L = 0.1 mH

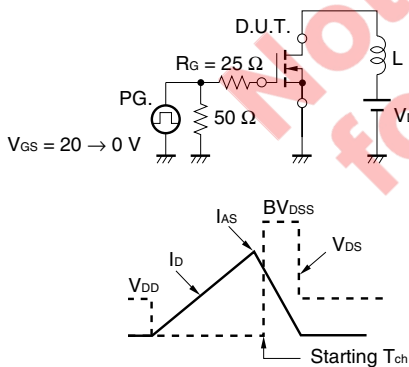
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ELECTRICAL CHARACTERISTICS (T_A = 25°C)

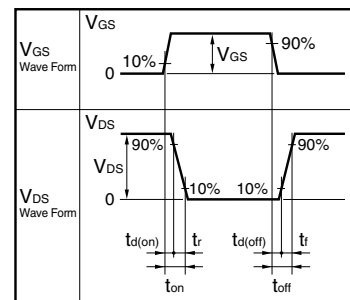
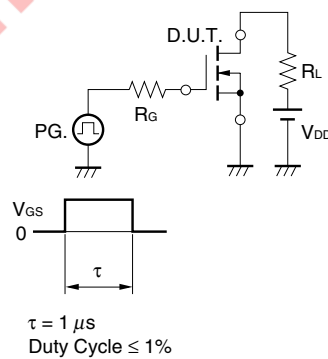
| CHARACTERISTICS | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-------------------------------------------------|----------------------|-------------------------------------------------------------|------|------|------|------|
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 25 V, V _{GS} = 0 V | | | 10 | μA |
| Gate Leakage Current | I _{GSS} | V _{GS} = ±16 V, V _{DS} = 0 V | | | ±100 | nA |
| Gate to Source Threshold Voltage | V _{GS(th)} | V _{DS} = V _{GS} , I _D = 250 μA | 1.5 | | 3.0 | V |
| Forward Transfer Admittance Note | y _{fs} | V _{DS} = 5 V, I _D = 16 A | 12 | 27 | | S |
| Drain to Source On-state Resistance Note | R _{DS(on)1} | V _{GS} = 10 V, I _D = 30 A | | 4.2 | 6.0 | mΩ |
| | R _{DS(on)2} | V _{GS} = 4.5 V, I _D = 20 A | | 6.4 | 9.5 | mΩ |
| Input Capacitance | C _{iss} | V _{DS} = 15 V, V _{GS} = 0 V, | | 1700 | | pF |
| Output Capacitance | C _{oss} | f = 1 MHz | | 310 | | pF |
| Reverse Transfer Capacitance | C _{rss} | | | 200 | | pF |
| Turn-on Delay Time | t _{d(on)} | V _{DD} = 15 V, I _D = 30 A, | | 14 | | ns |
| Rise Time | t _r | V _{GS} = 10 V, | | 14 | | ns |
| Turn-off Delay Time | t _{d(off)} | R _G = 3 Ω | | 49 | | ns |
| Fall Time | t _f | | | 10 | | ns |
| Total Gate Charge | Q _G | V _{DD} = 15 V, | | 34 | | nC |
| Gate to Source Charge | Q _{GS} | V _{GS} = 10 V, | | 5 | | nC |
| Gate to Drain Charge | Q _{GD} | I _D = 30 A | | 10 | | nC |
| Body Diode Forward Voltage Note | V _{F(S-D)} | I _F = 30 A, V _{GS} = 0 V | | 0.86 | 1.5 | V |
| Reverse Recovery Time | t _{rr} | I _F = 30 A, V _{GS} = 0 V, | | 29 | | ns |
| Reverse Recovery Charge | Q _{rr} | di/dt = 100 A/μs | | 20 | | nC |

Note Pulsed

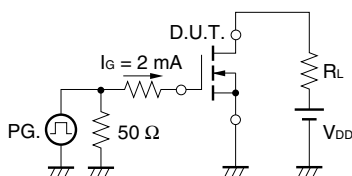
TEST CIRCUIT 1 AVALANCHE CAPABILITY



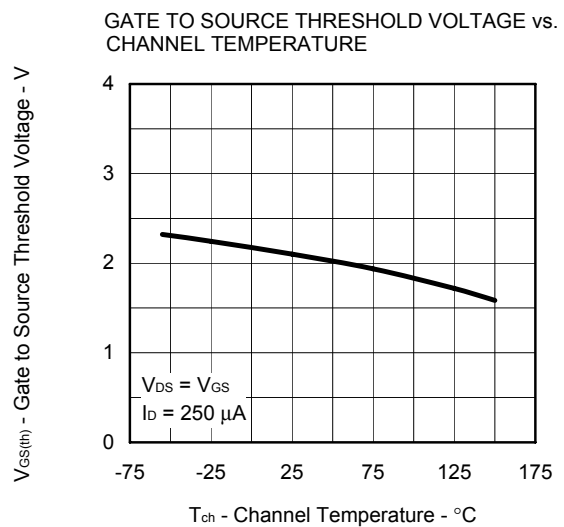
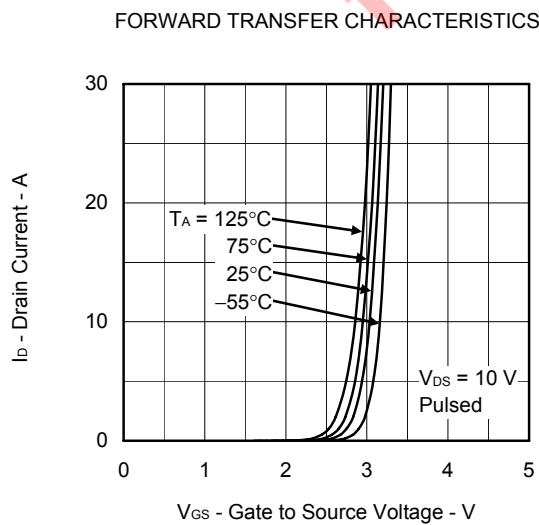
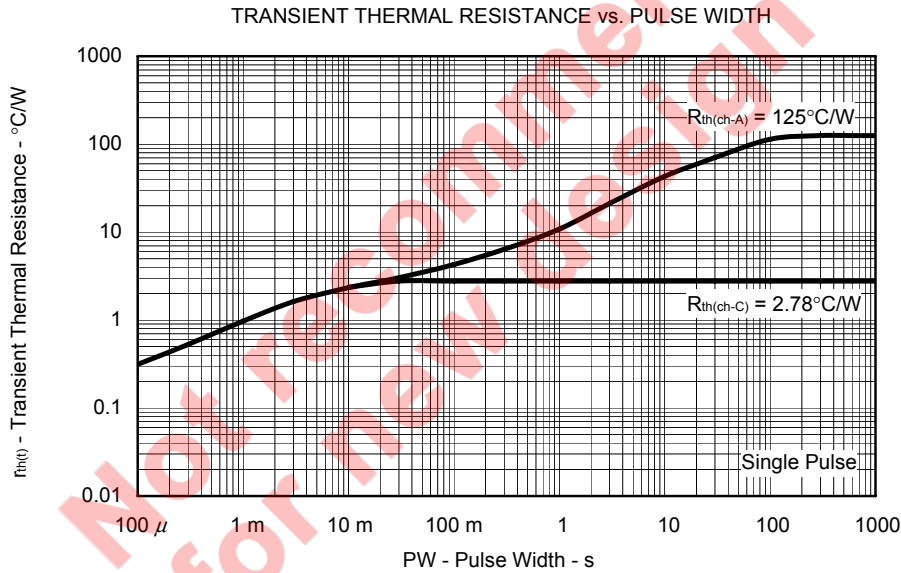
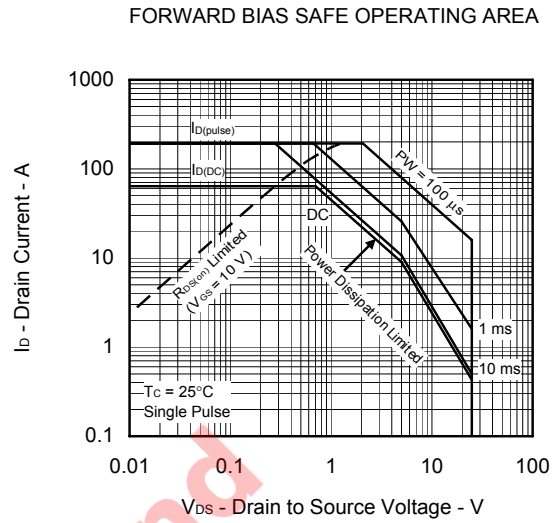
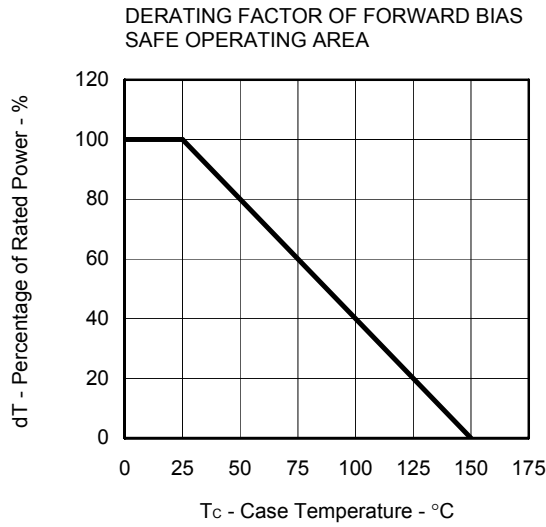
TEST CIRCUIT 2 SWITCHING TIME

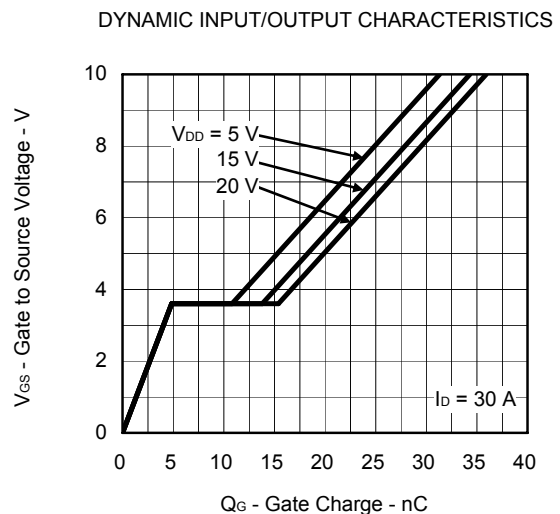
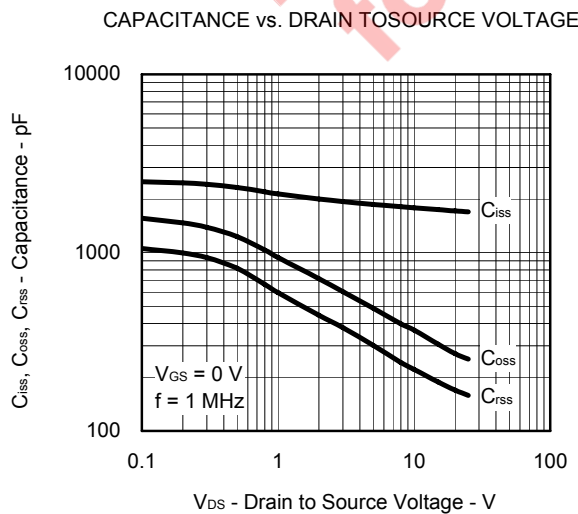
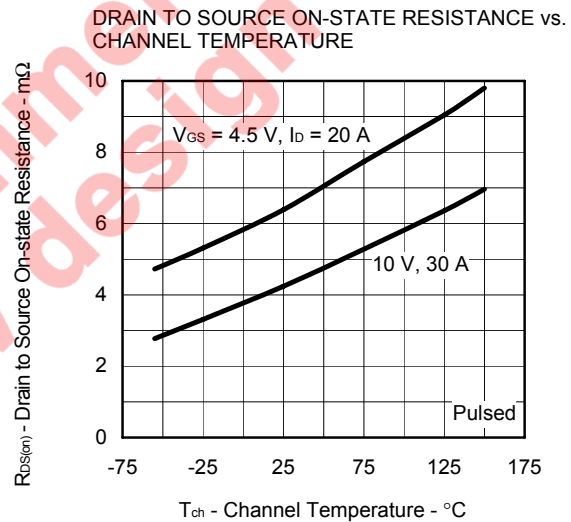
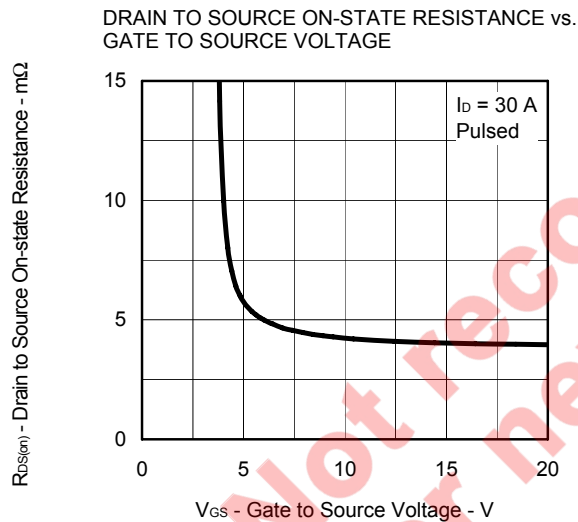
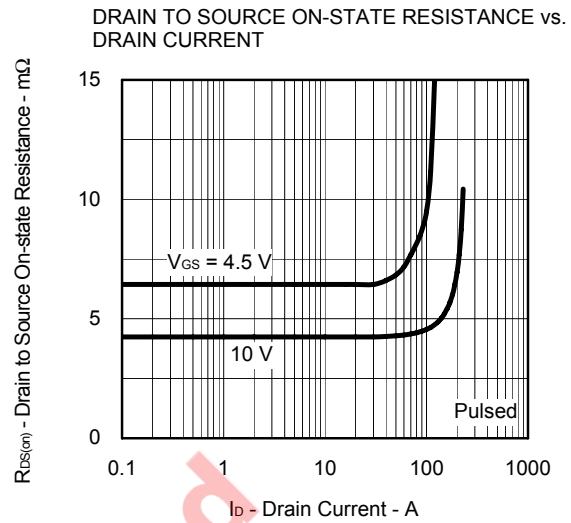
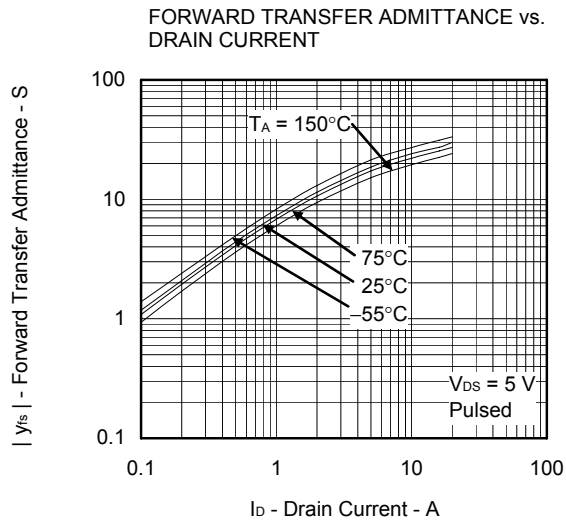


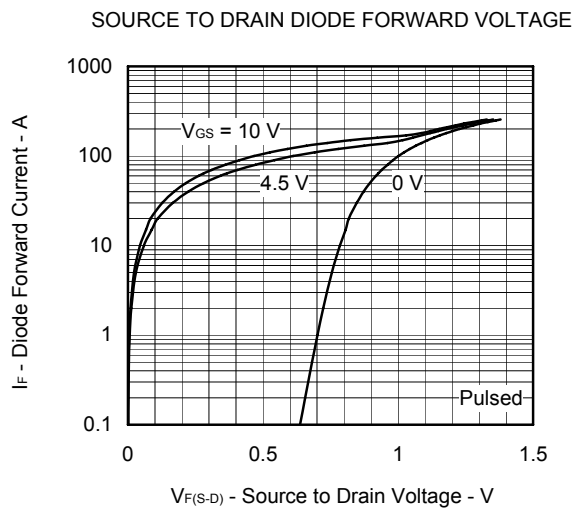
TEST CIRCUIT 3 GATE CHARGE



TYPICAL CHARACTERISTICS (T_A = 25°C)







Not recommend
for new design

